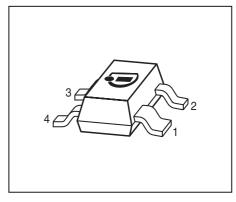


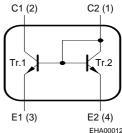
NPN Silicon Double Transistor

- To be used as a current mirror
- ullet Good thermal coupling and V_{BE} matching
- High current gain
- Low collector-emitter saturation voltage
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101









Туре	Marking	Pin Configuration Pa				Package
BCV61B	1Ks	1 = C2	2 = C1	3 = E1	4 = E2	SOT143
BCV61C	1Ls	1 = C2	2 = C1	3 = E1	4 = E2	SOT143

Maximum Ratings

Junction - soldering point¹⁾

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	30	V	
(transistor T1)				
Collector-base voltage (open emitter)	V _{CBO}	30		
(transistor T1)				
Emitter-base voltage	V _{EBS}	6		
DC collector current	I _C	100	mA	
Peak collector current, $t_p < 10 \text{ ms}$	I _{CM}	200		
Base peak current (transistor T1)	I _{BM}	200		
Total power dissipation, $T_S = 99 ^{\circ}\text{C}$	P _{tot}	300	mW	
Junction temperature	$T_{\rm j}$	150		
Storage temperature	$T_{\rm stq}$	-65 150		

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

K/W

≤170

 R_{thJS}



Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics of T1					•
Collector-emitter breakdown voltage	V _{(BR)CEO}	30	-	-	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0					
Collector-base breakdown voltage	V _{(BR)CBO}	30	-	-	
$I_{\rm C} = 10 \ \mu \text{A}, I_{\rm E} = 0$					
Emitter-base breakdown voltage	$V_{(BR)EBO}$	6	-	-	
$I_{\rm E}$ = 10 μ A, $I_{\rm C}$ = 0	. ,				
Collector cutoff current	I _{CBO}	-	-	15	nA
$V_{\rm CB} = 30 \text{ V}, I_{\rm E} = 0$					
Collector cutoff current	I _{CBO}	-	-	5	μA
V_{CB} = 30 V, I_{E} = 0 , T_{A} = 150 °C					
DC current gain ¹⁾	h _{FE}	100	-	-	-
$I_{\rm C}$ = 0.1 mA, $V_{\rm CE}$ = 5 V					
DC current gain ¹⁾	h _{FE}				
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, BCV61B		200	290	450	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V, BCV61C		420	520	800	
Collector-emitter saturation voltage ¹⁾	V _{CEsat}				mV
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA		-	90	250	
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 5 mA		-	200	600	
Base-emitter saturation voltage ¹⁾	V _{BEsat}				
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA		-	700	-	
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 5 mA		_	900	-	
Base-emitter voltage ¹⁾	V _{BE(ON)}	_			
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V		580	660	700	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V		-	_	770	

¹Puls test: t ≤ 300 µs, D = 2%

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Electrical Characteristics at T_A = 25°C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics			•		
Base-emitter forward voltage	V_{BES}				V
<i>I</i> _E = 10 μA		0.4	-	-	
I _E = 250 mA		-	-	1.8	
Matching of transistor T1 and transistor T2	I _{C1} / I _{C2}				-
at I_{E2} = 0.5mA and V_{CE1} = 5V		_	-	-	
T _A = 25 °C		0.7	-	1.3	
<i>T</i> _A = 150 °C		0.7	-	1.3	
Thermal coupling of transistor T1 and	I _{E2}	-	5	-	mA
transistor T2 ¹⁾ T1: V _{CE} = 5V					
Maximum current of thermal stability of I_{C1}					
AC characteristics for transistor T1	•		•	•	1
Transition frequency	f_{T}	-	250	-	MHz
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, f = 100 MHz					
Collector-base capacitance	C _{cb}	-	0.95	-	pF
$V_{\rm CB}$ = 10 V, f = 1 MHz					
Emitter-base capacitance	C _{eb}	-	9	-	1
$V_{\rm EB}$ = 0.5 V, f = 1 MHz					
Noise figure	F	-	2	-	dB
$I_{\rm C}$ = 200 μA, $V_{\rm CE}$ = 5 V, $R_{\rm S}$ = 2 kΩ,					
f = 1 kHz, Δ f = 200 Hz					
Short-circuit input impedance	h _{11e}	-	4.5	-	kΩ
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz					
Open-circuit reverse voltage transf.ratio	h _{12e}	-	2	-	10-4
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz	120				
Short-circuit forward current transf.ratio	h _{21e}	100	_	900	_
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz	210				
Open-circuit output admittance	h _{22e}	-	30	-	μS
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz	226				

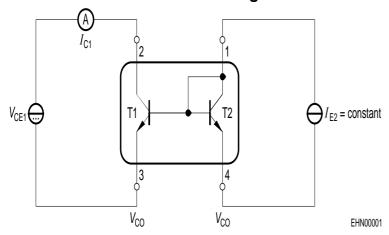
¹⁾ Witout emitter resistor. Device mounted on alumina 15mm x 16.5mm x 0.7mm

3

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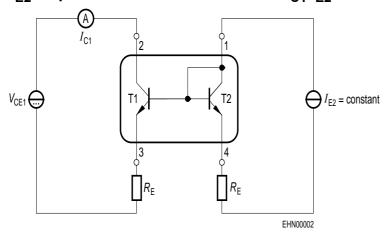


Test circuit for current matching



Note: Voltage drop at contacts: $V_{CO} < 2/3 V_{T} = 16$ mV

Characteristic for determination of $V_{\rm CE1}$ at specified $R_{\rm E}$ range with $I_{\rm E2}$ as parameter under condition of $I_{\rm C1}/I_{\rm E2}$ = 1.3



Note: BCV61 with emitter resistors

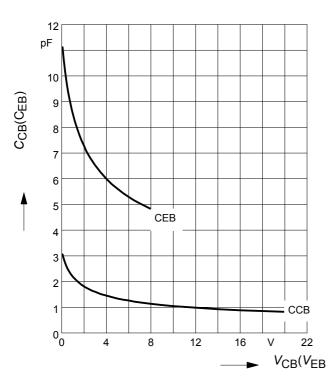
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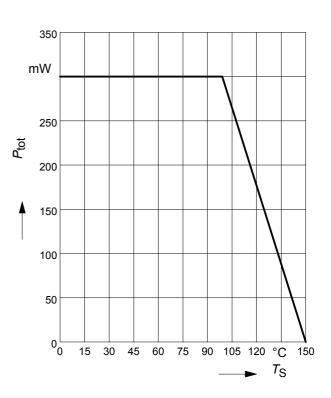
4



Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$

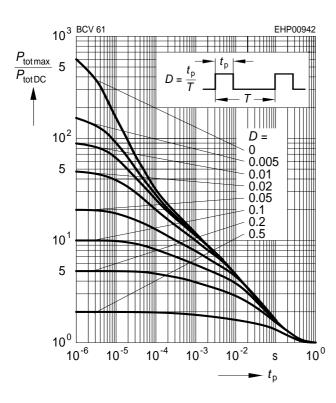
Total power dissipation $P_{tot} = f(T_S)$





Permissible pulse load

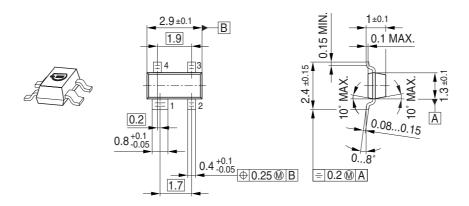
$$P_{\text{totmax}} / P_{\text{totDC}} = f(t_{p})$$



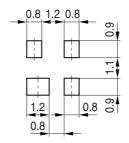
5



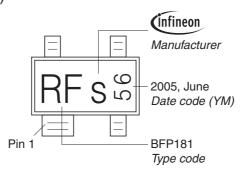
Package Outline



Foot Print

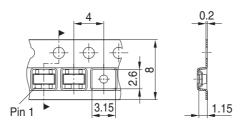


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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